

# (19) United States

## (12) Patent Application Publication (10) Pub. No.: US 2024/0237380 A1 MEI et al.

Jul. 11, 2024 (43) **Pub. Date:** 

### (54) LIGHT-EMITTING SUBSTRATE AND MANUFACTURING METHOD THEREOF, AND LIGHT-EMITTING APPARATUS

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(21) Appl. No.: 17/913,474

(22)PCT Filed: Sep. 14, 2021

(86) PCT No.: PCT/CN2021/118275

§ 371 (c)(1),

(2) Date: Sep. 22, 2022

### **Publication Classification**

(51) **Int. Cl.** H10K 50/115 (2023.01)H10K 59/35 (2023.01)H10K 71/20 (2023.01) H10K 85/10 (2023.01)H10K 50/16 (2023.01)

(52) U.S. Cl.

CPC ...... H10K 50/115 (2023.02); H10K 59/35 (2023.02); H10K 71/231 (2023.02); H10K 85/111 (2023.02); H10K 50/16 (2023.02)

#### (57)ABSTRACT

A light-emitting substrate includes a plurality of lightemitting devices including at least one first light-emitting device and at least one second light-emitting device. A first light-emitting device in the at least one first light-emitting device includes a first color light-emitting layer. A second light-emitting device in the at least one second light-emitting device includes another first color light-emitting layer, and a first material layer and a second color light-emitting layer that are sequentially stacked on the another first color light-emitting layer. The first material layer is configured to transport holes transported from the first color light-emitting layer to the second color light-emitting layer, and to block electrons transported from the second color light-emitting layer; or the first material layer is configured to transport electrons transported from the first color light-emitting layer to the second color light-emitting layer, and to block holes transported from the second color light-emitting layer.



